

LINEAR TECHNOLOGY MATERIALS DECLARATION

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(Engineering Calculation)

MSOP

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TOTAL MASS (g) : 0.026959

COMPONENT MATERIAL	VENDOR/ INDUSTRY NAMES	CONSTITUENT NAME	CAS NUMBER	CONSTITUENT MASS (g)	CONSTITUENT (PPM) OF MATERIAL	CONSTITUENT (PPM) OF TOTAL PKG.		
Active Device	Linear Technology	Silicon (Si)	7440-21-3	0.001750	1000000	64913.3242188		
Die Coat	Dow Corning	Silicone	69430-27-9	0.000000	0	0		
Lead Frame	Cu	Copper (Cu)	7440-50-8	0.010433	975000	386994.65625		
		Iron (Fe)	7439-89-6	0.000257	24000	9532.98535156		
		Phosphorus (P)	7723-14-0	0.000003	300	111.279983521		
		Zinc (Zn)	7440-66-6	0.000007	700	259.653289795		
		Nickel (Ni)	7440-02-0	0.000000	0	0		
		Silicon (Si)	7440-21-3	0.000000	0	0		
		Magnesium (Mg)	7439-95-4	0.000000	0	0		
		Tin (Sn)	7440-31-5	0.000000	0	0		
Lead Frame Total:				0.010700	1000000	396898.625		
Plating	PMI	Exter. Plating Pb	7439-92-1	0.000000	0	0		
		Exter. Plating Sn	7440-31-5	0.000710	1000000	26337.1894531		
		External Plating Total:				0.000710	1000000	26337.1894531
		Inter. Plating Ni	7440-02-0	0.000000	0	0		
		Inter. Plating Ag	7440-22-4	0.000086	1000000	3190.02612305		
		Internal Plating Total:				0.000086	1000000	3190.02612305
Die Attach	ELECTRICALLY CONDUCTIVE ADHESIVE	Silver (Ag)	7440-22-4	0.000647	750000	23999.3808594		
		Tin (Sn)	7440-31-5	0.000000	0	0		
		Lead (Pb)	7439-92-1	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.000000	0	0		
		Indium (In)	7440-74-6	0.000000	0	0		
		Metal Oxide		0.000000	0	0		
		Antimony (Sb)	7440-36-0	0.000000	0	0		
		Resin (EP)		0.000216	250000	8012.15869141		
Die Attach Total:				0.000863	1000000	32011.5429688		
Encapsulation	MULTI-AROMATIC RESIN Br/Sb FREE	Resin (EP)		0.001659	130000	61537.828125		
		Bromine (Br)	40039-93-8	0.000000	0	0		
		Silica (SiO2)	60676-86-0	0.010591	830000	392855.4375		
		Antimony Trioxide (Sb2O3)	1309-64-4	0.000000	0	0		
		Metal Hydroxide		0.000447	35000	16580.7167969		
		Carbon Black (C)	1333-86-4	0.000064	5000	2373.97290039		
		Encapsulation Total:				0.012761	1000000	473347.9375
Bond Wire Estimated	AFW/TANAKA/ Kn	Gold (Au)	7440-57-5	0.000089	1000000	3301.30615234		
					TOTAL MASS (g) :	0.026959		